

Low-Voltage Quad 2-Input OR Gate with 5V Tolerant Inputs and Outputs

The TC74LCX32 is a high performance CMOS 2-INPUT OR GATE. Designed for use in 3.3 Volt systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

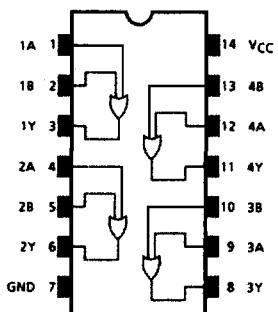
The device is designed for low voltage (3.3V) V_{CC} applications, but it could be used to interface to 5V supply environment for inputs.

All inputs are equipped with protection circuits against static discharge.

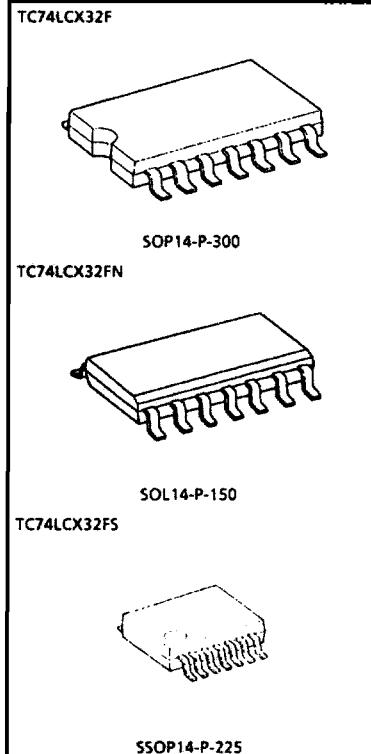
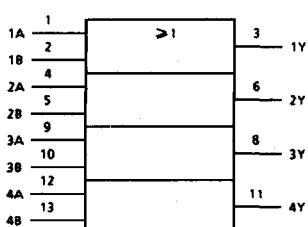
Features

- Low Voltage Operation: $V_{CC} = 2.0 \sim 3.6V$
- High Speed: $t_{pd} = 5.5ns$ (Max.) ($V_{CC} = 3.0 \sim 3.6V$)
- Output Current: $I_{OHL}/I_{OL} = 24mA$ (Min.) ($V_{CC} = 3.0V$)
- Latch up Performance: $\pm 500mA$
- Available in JEDEC SOP, EIAJ SOP and SSOP
- Power down protection is provided on all inputs and outputs
- Pin and Function Compatible with 74 series
 - (74AC/VHC/HC/F/ALS/LS, etc.) 32 type

Pin Connection



IEC Logic Symbol



Weight SOP14-P-300 : 0.18g (Typ.)
SOL14-P-150 : 0.12g (Typ.)
SSOP14-P-225 : 0.07g (Typ.)

Pin Assignment

Inputs		Outputs
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	H

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Supply Voltage Range	V _{CC}	-0.5 ~ 7.0	V
DC Input Voltage	V _{IN}	-0.5 ~ 7.0	V
DC Output Voltage	V _{OUT}	-0.5 ~ 7.0 (Note 1)	V
		-0.5 - V _{CC} + 0.5 (Note 2)	V
Input Diode Current	I _{IK}	-50	mA
Output Diode Current	I _{OK}	±50 (Note 3)	mA
DC Output Current	I _{OUT}	±50	mA
Power Dissipation	P _D	180	mW
DC V _{CC} /Ground Current	I _{CC/GND}	±100	mA
Storage Temperature	T _{stg}	-65 ~ 150	°C

(Note 1) Off-State

(Note 2) High or Low State. I_{out} absolute maximum rating must be observed.

(Note 3) $V_{out} < GND$, $V_{out} > V_{cc}$

Recommended Operating Conditions

Parameter	Symbol	Value	Unit
Supply Voltage	V_{CC}	2.0 ~ 3.6	V
		1.5 ~ 3.6 (Note 4)	
Input Voltage	V_{IN}	0 ~ 5.5	V
		0 ~ 5.5 (Note 5)	
Bus Output Voltage	V_{OUT}	0 ~ V_{CC} (Note 6)	V
		± 24 (Note 7)	
Output Current	I_{OH}/I_{OL}	± 12 (Note 8)	mA
		-40 ~ 85	°C
Operating Temperature	T_{opr}	0 ~ 10 (Note 9)	ns/V
Input Rise and Fall Time	dV/dt		

(Note 4) Data Retention Only

(Note 5) Off-State

(Note 6) High or Low State

(Note 7) $V_{CC} = 3.0 \sim 3.6V$

(Note 8) $V_{CC} = 2.7 \sim 3.0V$

(Note 9) $V_{IN} = 0.8 \sim 2.0V$, $V_{CC} = 3.0V$

Electrical Characteristics

DC Characteristics ($T_a = -40 \sim 85^\circ\text{C}$)

Parameter		Symbol	Test Condition		V _{CC} (V)	Min.	Max.	Unit	
Input Voltage	"H" Level		-			2.7 ~ 3.6	2.0	-	V
	"L" Level	V _{IL}	-			2.7 ~ 3.6	-	0.8	V
Output Voltage	"H" Level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100µA	2.7 ~ 3.6	V _{CC} - 0.2	-		
				I _{OH} = -12mA	2.7	2.2	-		
				I _{OH} = -18mA	3.0	2.4	-		
				I _{OH} = -24mA	3.0	2.2	-	V	
	"L" Level	V _{OL}	V _{IN} = V _{IL}	I _{OH} = 100µA	2.7 ~ 3.6	-	0.2		
				I _{OL} = 12mA	2.7	-	0.4		
				I _{OL} = 16mA	3.0	-	0.4		
				I _{OH} = 24mA	3.0	-	0.55	V	
Input Leakage Current		I _{IN}	V _{IN} = 0 ~ 5.5V		2.7 ~ 3.6	-	±5.0	µA	
Power Off Leakage Current		I _{OFF}	V _{IN} /V _{OUT} = 5.5V		0	-	10.0	µA	
Quiescent Supply Current		I _{CC}	V _{IN} = V _{CC} or GND		2.7 ~ 3.6	-	10.0		
			V _{IN} /V _{OUT} = 3.6 ~ 5.5V		2.7 ~ 3.6	-	±10.0	µA	
Increase in I _{CC} per Input		ΔI _{CC}	V _{IH} = V _{CC} - 0.6V		2.7 ~ 3.6	-	500	µA	

AC Characteristics (Ta = -40 ~ 85°C)

Parameter	Symbol	Test Condition	V _{CC} (V)	Min.	Max.	Unit
Propagation Delay Time	t _{pLH} t _{pHL}	(Fig. 1, 2)	2.7	—	6.2	ns
			3.3±0.3	1.5	5.5	
Output to Output Skew	t _{osLH} t _{osHL}	(Note 10)	2.7	—	—	ns
			3.3±0.3	—	1.0	

(Note 10) Parameter guaranteed by design. (t_{osLH} = | t_{pLHm} - t_{pLHn} |, t_{osHL} = | t_{pHLM} - t_{pHLn} |)

Dynamic Switching Characteristics (Ta = 25°C, Input t_r = t_f = 2.5ns, C_L = 50pF, R_L = 500Ω)

Parameter	Symbol	Test Condition	V _{CC} (V)	Typical	Unit
Quiet Output Maximum Dynamic V _{OL}	V _{OLP}	V _{IH} = 3.3V, V _{IL} = 0V	3.3	0.8	V
Quiet Output Minimum Dynamic V _{OL}	V _{OVL}	V _{IH} = 3.3V, V _{IL} = 0V	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

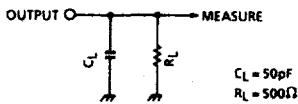
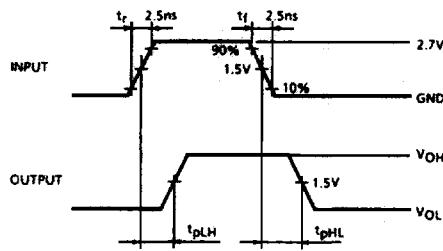
Parameter	Symbol	Test Condition	V _{CC} (V)	Typical	Unit
Input Capacitance	C _{IN}	—	3.3	7	pF
Bus Input Capacitance	C _{OUT}	—	3.3	8	pF
Power Dissipation Capacitance	C _{PD}	f _{IN} = 10MHz (Note 11)	3.3	25	pF

(Note 11) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation: I_{CC} (opr.) = C_{PD} • V_{CC} • f_{IN} + I_{CC}/4 (per gate)

TEST CIRCUIT

Fig.1

**AC WAVEFORM**Fig.2 t_{pLH} , t_{pHL} 

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